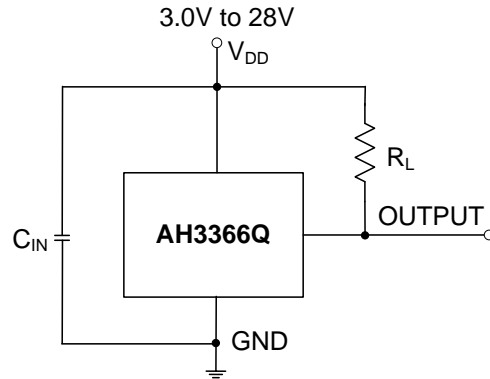


Typical Applications Circuit (Note 4)



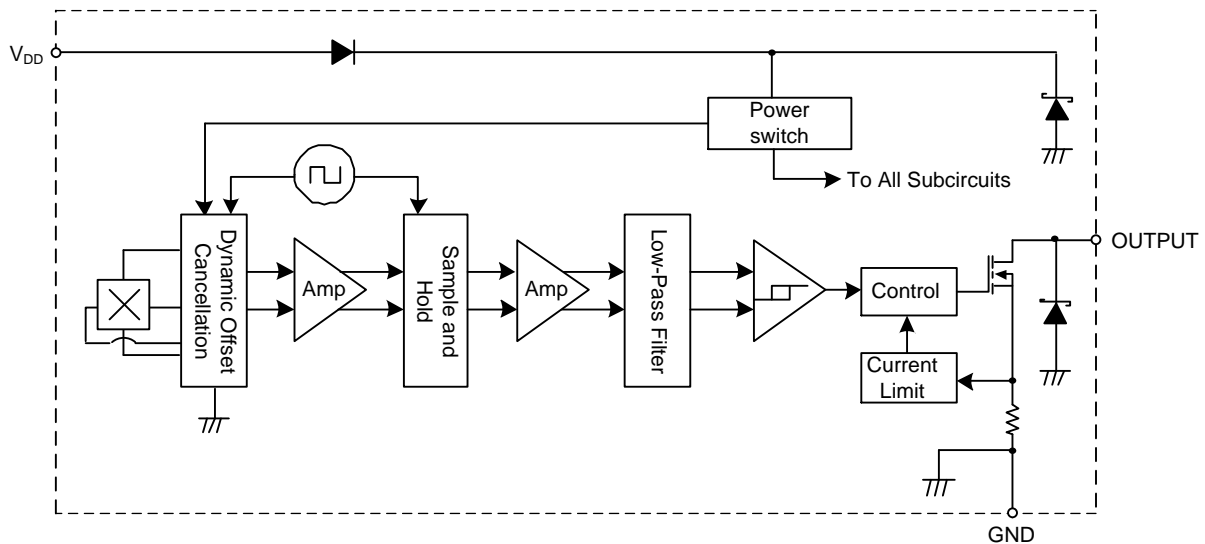
Note: 4. C_{IN} is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 10nF ~ 100nF.
 R_L is the pull-up resistor.

Pin Descriptions

Package: SC59, SOT23 and SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)

Pin Number	Pin Name	Function
1	V_{DD}	Power Supply Input
2	GND	Ground
3	OUTPUT	Output Pin

Functional Block Diagram



Absolute Maximum Ratings (Note 5 & 6) (@T_A = +25°C, unless otherwise specified.)

Symbol	Characteristic		Value	Unit
V _{DD}	Supply Voltage (Note 6)		32	V
V _{DDR}	Reverse Supply Voltage (Note 6)		-32	V
V _{OUT_MAX}	Output Off Voltage (Note 6)		32	V
I _{OUT}	Continuous Output Current		60	mA
I _{OUT_R}	Reverse Output Current		-50	mA
B	Magnetic Flux Density		Unlimited	
P _D	Package Power Dissipation	SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)	550	mW
		SC59 and SOT23	230	
T _s	Storage Temperature Range		-65 to +165	°C
T _J	Maximum Junction Temperature		+150	°C
ESD HBM	Electros Static Discharge Withstand - Human Body Model (HMB)		8	kV
ESD MM	Electros Static Discharge Withstand - Machine Model (MM)		800	V
ESD CDM	Electros Static Discharge Withstand - Charged Device Model (CDM)		2	kV

Notes: 5. Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
6. The absolute maximum V_{DD} of 32V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

Recommended Operating Conditions (@T_A = -40°C to +150°C, unless otherwise specified.)

Symbol	Parameter	Condition	Rating	Unit
V _{DD}	Supply Voltage	Operating	3.0 to 28	V
T _A	Operating Temperature Range	Operating	-40 to +150	°C

Electrical Characteristics (Note 7 & 8) (@T_A = -40°C to +150°C, V_{DD} = 3V to 28V, unless otherwise specified.)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
V _{OUT_ON}	Output ON Voltage	I _{OUT} = 20mA, B > Bop	-	0.2	0.4	V
I _{LKG}	Output Leakage Current (When output is off)	V _{OUT} = 28V, B < Brp, Output off	-	<0.1	10	μA
I _{DD}	Supply Current	Output open, T _A = +25°C	-	3	3.5	mA
		Output open, T _A = -40°C to +150°C	-	-	4	mA
I _{DD_R}	Reverse Supply Current	V _{DD} = -18V, T _A = +25°C	-	0.6	-	μA
		V _{DD} = -18V, T _A = -40°C to +150°C	-	0.6	1500	μA
		V _{DD} = -28V, T _A = +25°C	-	1.6	-	μA
		V _{DD} = -28V, T _A = -40°C to +150°C	-	1.6	2500	μA
t _{P_ON}	Device Power-On Time (Start-up time)	V _{DD} ≥ 3V, B > Bop (Note 7)	-	10	-	μs
f _C	Chopping Frequency	-	-	800	-	kHz
t _D	Response Time Delay (Time from magnetic threshold reached to the start of the output rise or fall)	(Note 9)	-	3.75	-	μs
t _R	Output Rising Time (External pull-up resistor R _L and load capacitance dependent)	R _L = 1kΩ, C _L = 20pF	-	0.2	1	μs
t _F	Output Falling Time (Internal switch resistance and load capacitance dependent)	R _L = 1kΩ, C _L = 20pF	-	0.1	1	μs
I _{OCL}	Output Current Limit	B > Bop, (Note 10)	30	-	55	mA
V _Z	Zener Clamp Voltage	I _{DD} = 5mA	28	-	-	V

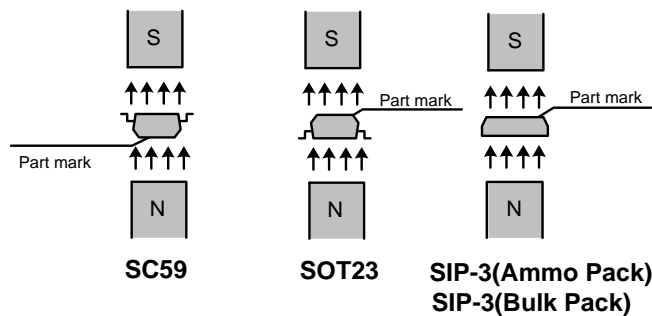
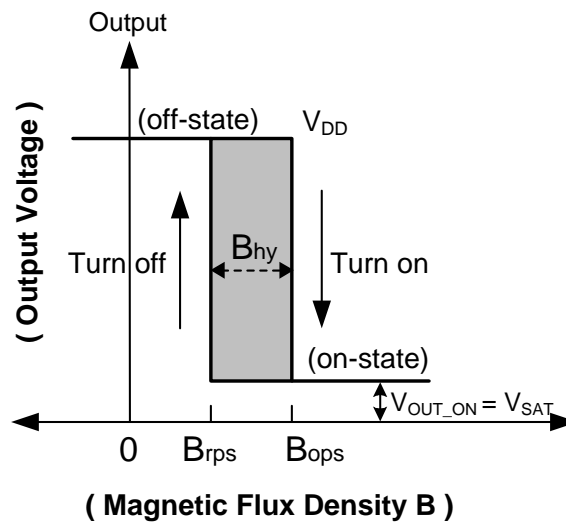
Notes: 7. When power is initially turned on, V_{DD} must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10μs typical from the operating voltage reaching 3V.
8. Typical values are defined at T_A = +25°C, V_{DD} = 12V. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization.
9. Guaranteed by design, process control and characterization. Not tested in production.
10. The device will limit the output current I_{OUT} to current limit of I_{OCL}.

Magnetic Characteristics (Note 11 & 12) ($T_A = -40^\circ\text{C}$ to $+150^\circ\text{C}$, $V_{DD} = 3.0\text{V}$ to 28V , unless otherwise specified.)

(1mT=10 Gauss)

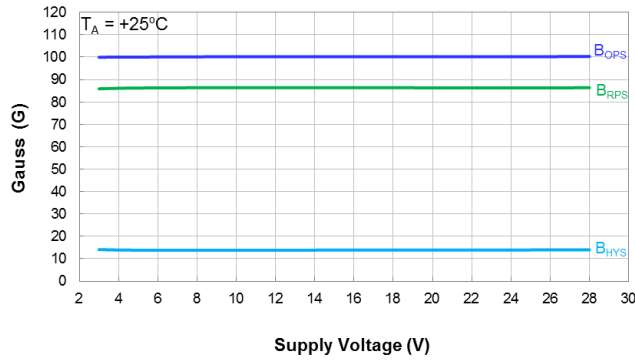
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
B_{OPS} (South pole to the part marking side for SOT23 and SIP-3 (Ammo Pack), SIP-3 (Bulk Pack) packages; South pole to the non-part marking side for SC59 package. See diagram below)	Operation Point	$V_{DD} = 12\text{V}$, $T_A = +25^\circ\text{C}$	-	100	-	Gauss
		$T_A = -40^\circ\text{C}$ to $+150^\circ\text{C}$	65	100	135	
B_{RPS} (South pole to the part marking side for SOT23 and SIP-3 (Ammo Pack), SIP-3 (Bulk Pack) packages; South pole to the non-part marking side for SC59 package. See diagram below)	Release Point	$V_{DD} = 12\text{V}$, $T_A = +25^\circ\text{C}$	-	85	-	
		$T_A = -40^\circ\text{C}$ to $+150^\circ\text{C}$	50	85	120	
B_{HY} ($ B_{OPX} - B_{RPX} $)	Hysteresis (Note 13)	$V_{DD} = 12\text{V}$, $T_A = +25^\circ\text{C}$	-	15	-	
		$T_A = -40^\circ\text{C}$ to $+150^\circ\text{C}$	8	15	25	

- Notes:
- When power is initially turned on, V_{DD} must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10 μs typical from the operating voltage reaching 3V.
 - Typical values are defined at $T_A = +25^\circ\text{C}$, $V_{DD} = 12\text{V}$. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization.
 - Maximum and minimum hysteresis is guaranteed by design, process control and characterization.

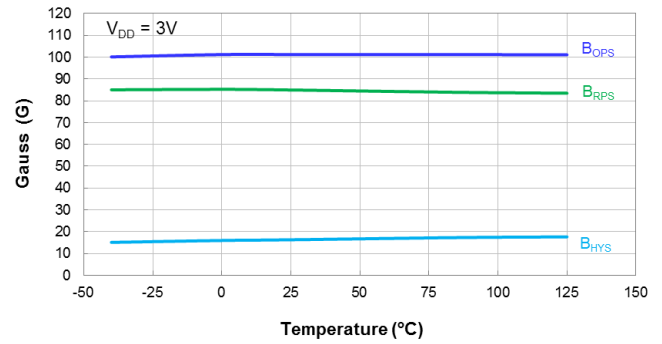


Typical Operating Characteristics

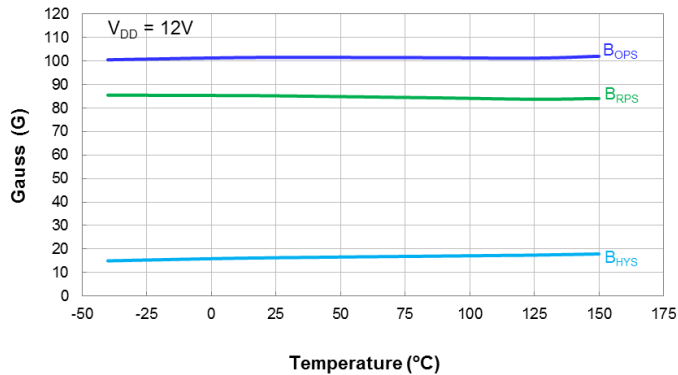
Output Switch Operate and Release Points (Magnetic Thresholds) – B_{OPS} and B_{RPS}



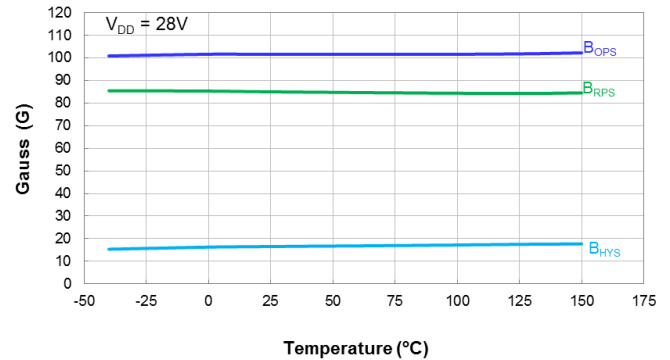
Switch Points B_{OPS} and B_{RPS} vs Supply Voltage



Switch Points B_{OPS} and B_{RPS} vs Temperature

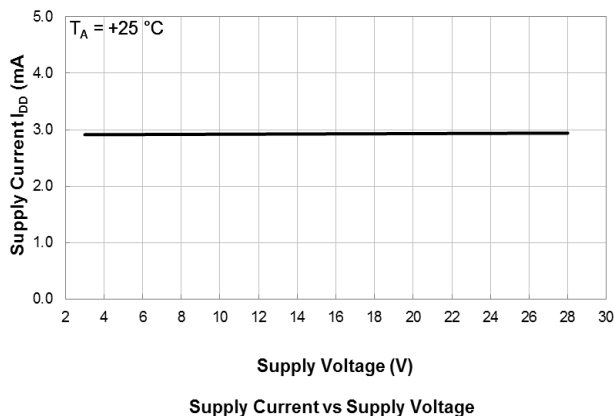


Switch Points B_{OPS} and B_{RPS} vs Temperature

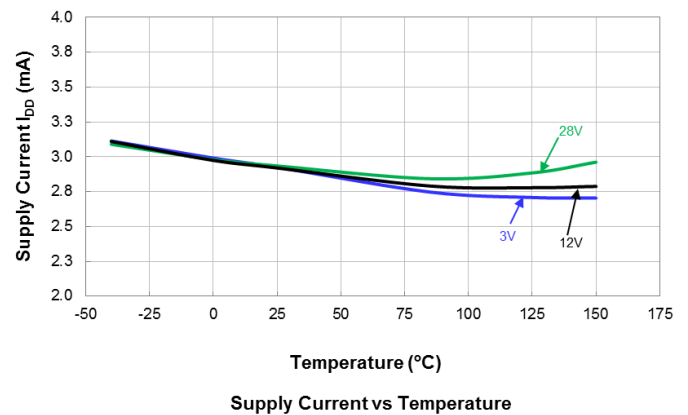


Switch Points B_{OPS} and B_{RPS} vs Temperature

Supply Current



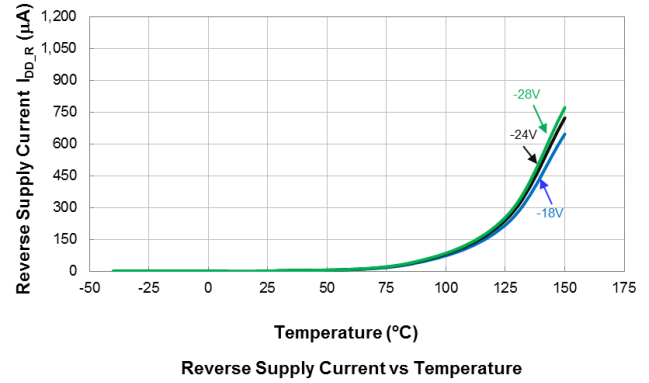
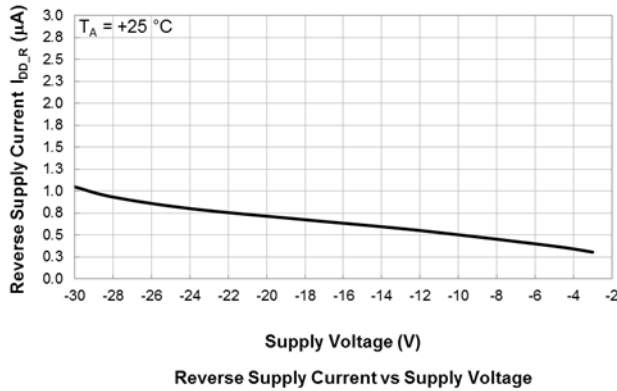
Supply Current vs Supply Voltage



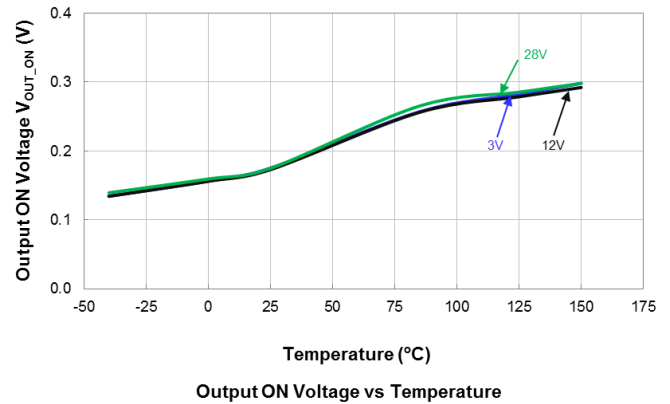
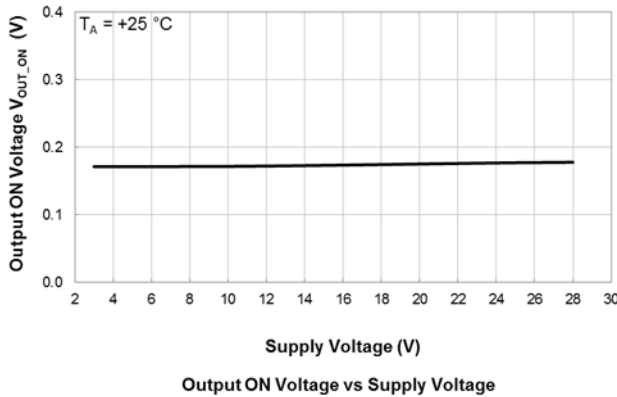
Supply Current vs Temperature

Typical Operating Characteristics (Cont.)

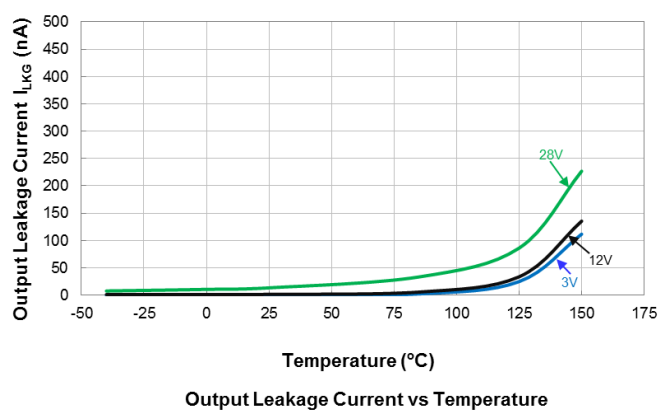
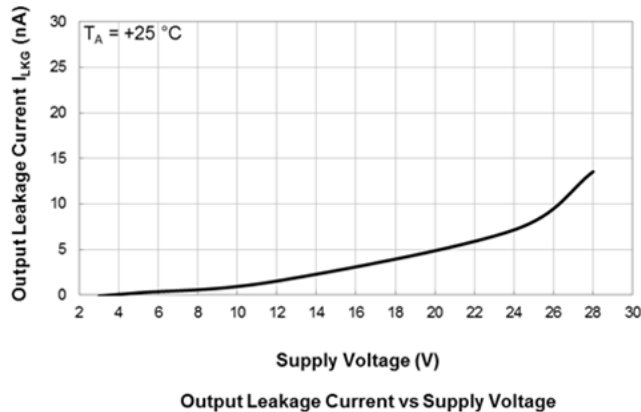
Supply Reverse Current



Output Switch On Voltage

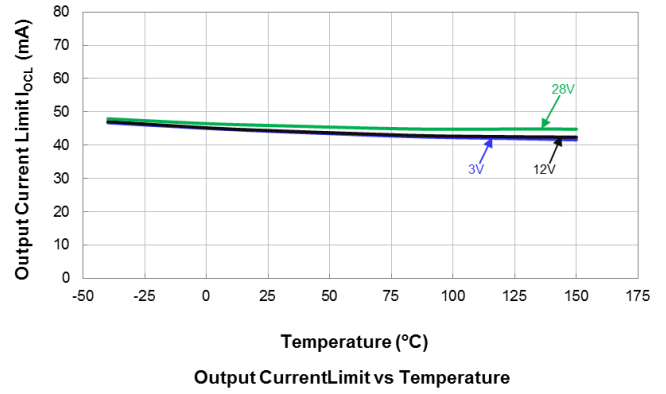
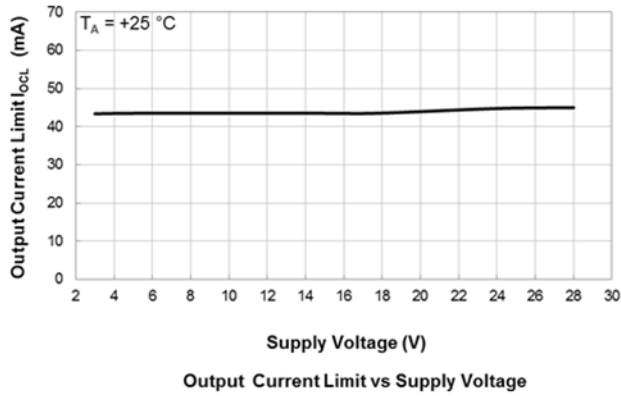


Output Switch Leakage Current



Typical Operating Characteristics (Cont.)

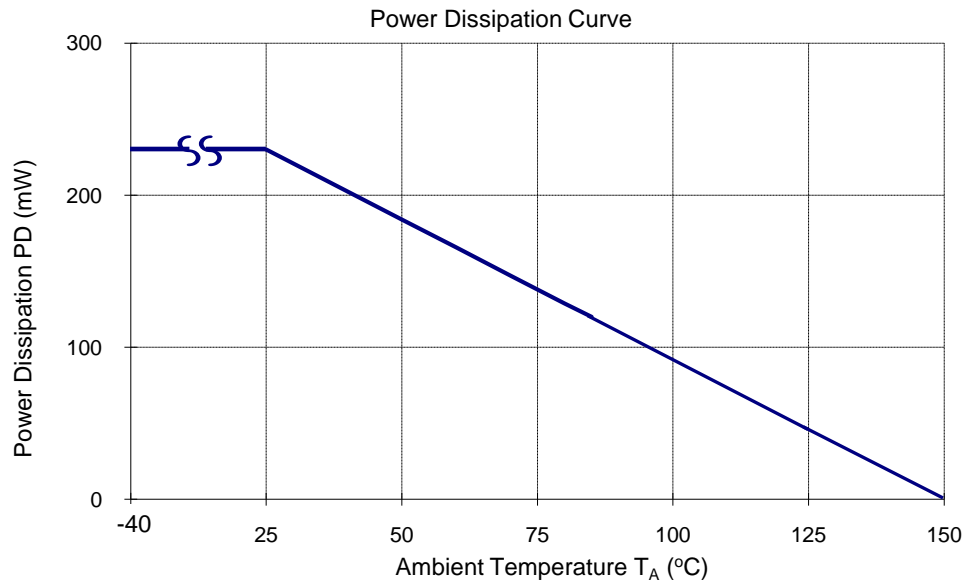
Output Current Limit



Thermal Performance Characteristics

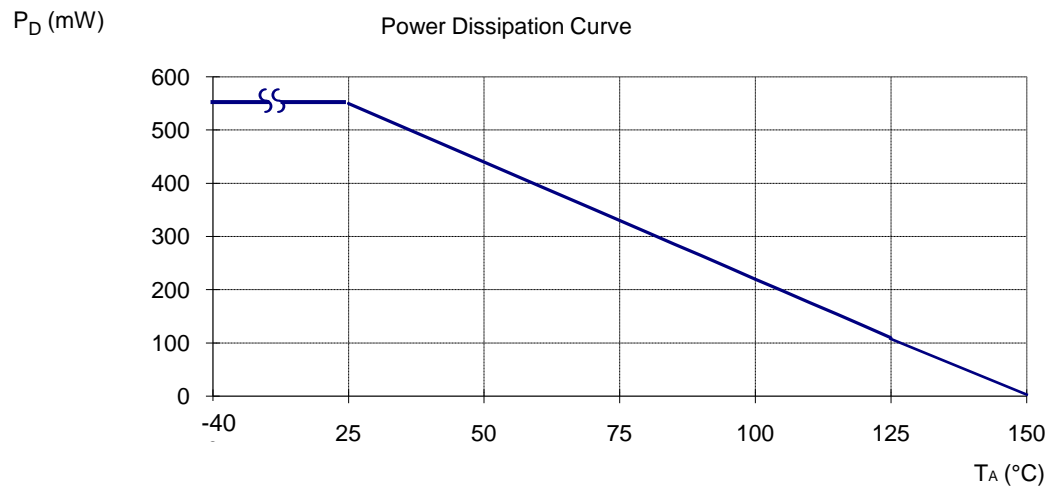
(1) Package type: SC59 and SOT23

T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	230	184	166	147	129	120	110	92	83	74	55	46	37	18	0

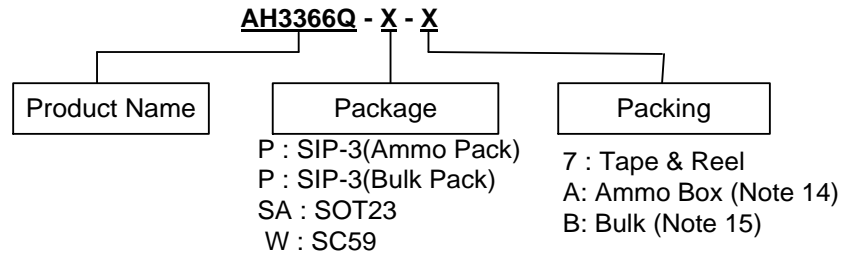


(2) Package type: SIP-3

T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	550	440	396	362	308	286	264	220	198	176	132	110	88	44	0



Ordering Information



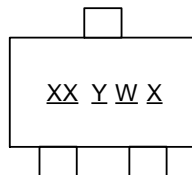
Part Number	Package Code	Packaging	Bulk Box		7" Tape and Reel		Ammo Box	
			Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH3366Q-P-A	P	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH3366Q-P-B	P	SIP-3 (Bulk Pack)	1000	-B	NA	NA	NA	NA
AH3366Q-SA-7	SA	SOT23	NA	NA	3000/Tape & Reel	-7	NA	NA
AH3366Q-W-7	W	SC59	NA	NA	3000/Tape & Reel	-7	NA	NA

Notes: 14. Ammo Box is for SIP-3 (Ammo Pack) Spread Lead.
15. Bulk is for SIP-3 (Bulk Pack) Straight Lead.

Marking Information

(1) Package Type: SC59 and SOT23

(Top View)

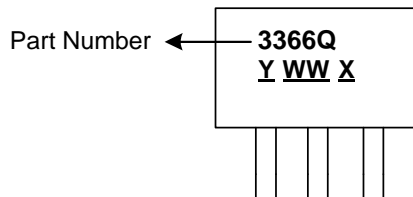


XX : Identification code
Y : Year 0 to 9
W : Week : A to Z : 1 to 26 week;
a to z : 27 to 52 week; z represents 52 and 53 week
X : Internal code

Part Number	Package	Identification Code
AH3366Q	SC59	DC
AH3366Q	SOT23	MJ

(2) Package Type: SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)

(Top View)



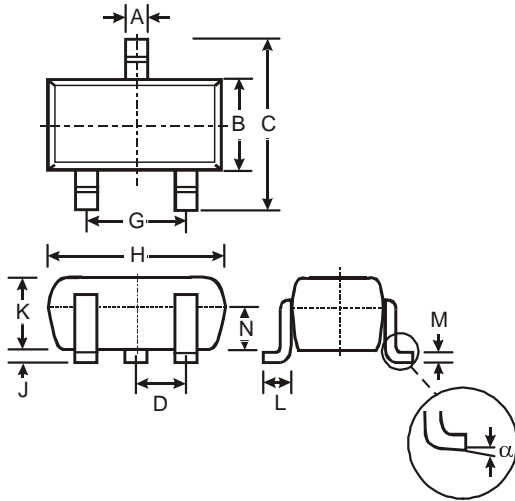
Y : Year : 0~9
WW : Week : 01~52, "52" represents 52 and 53 week
X : Internal Code

Part Number	Package	Identification Code
AH3366Q	SIP-3	3366Q

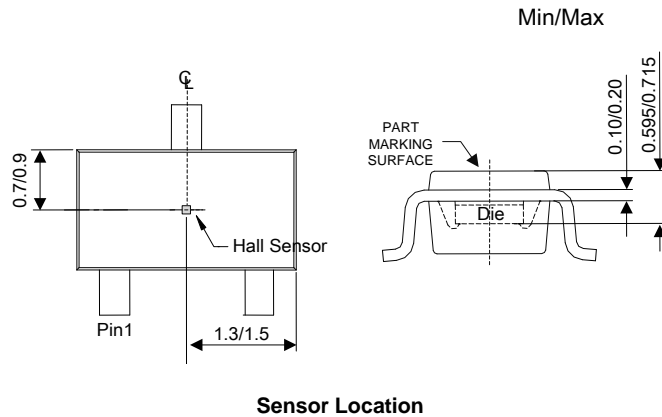
Package Outline Dimensions (All dimensions in mm.)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(1) Package Type: SC59



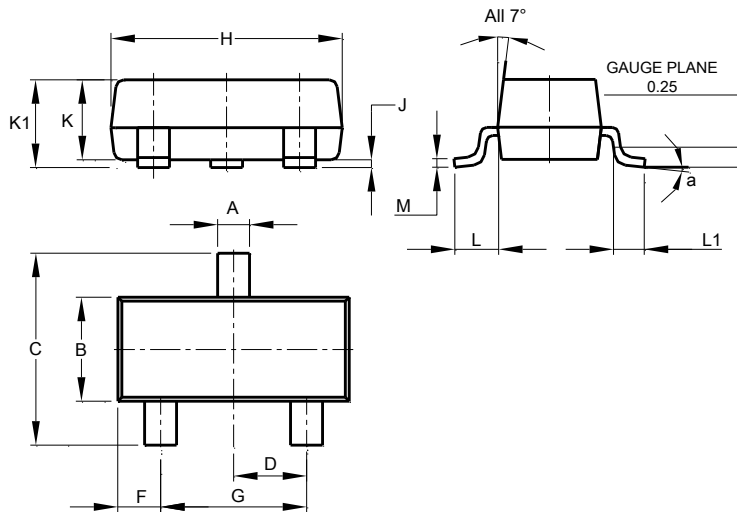
SC59			
Dim	Min	Max	Typ
A	0.35	0.50	0.38
B	1.50	1.70	1.60
C	2.70	3.00	2.80
D	-	-	0.95
G	-	-	1.90
H	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
M	0.10	0.20	0.15
N	0.70	0.80	0.75
α	0°	8°	-
All Dimensions in mm			



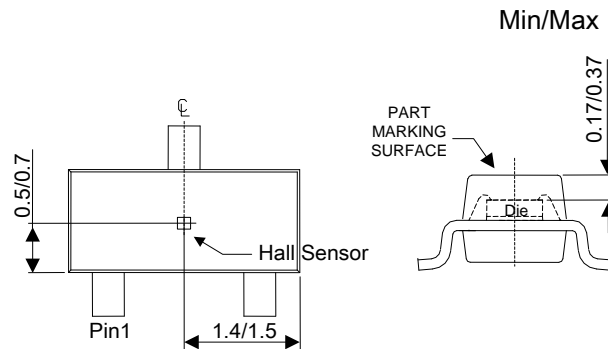
Sensor Location

Package Outline Dimensions (Cont.) (All dimensions in mm.)

(2) Package Type: SOT23



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

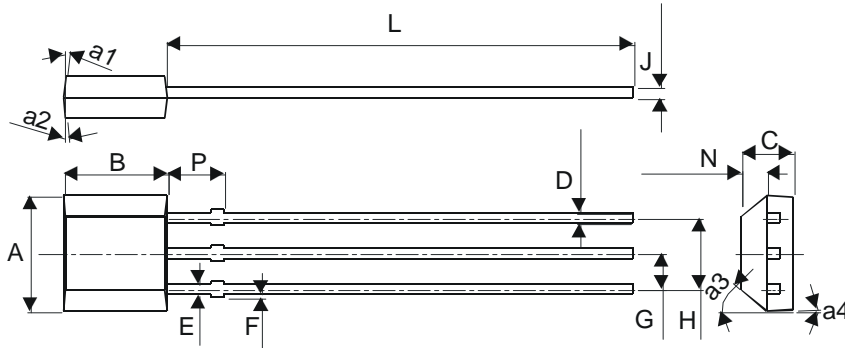


Sensor Location

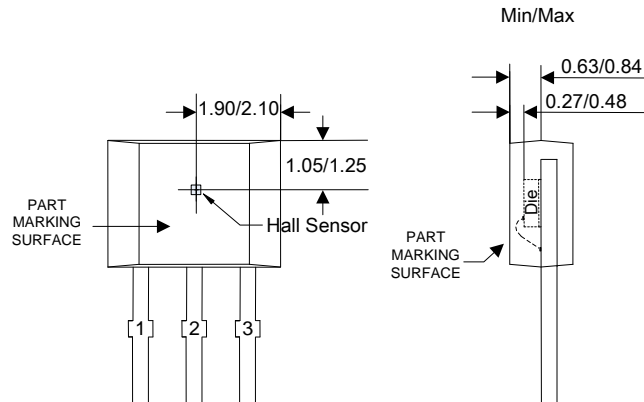
Package Outline Dimensions (Cont.) (All dimensions in mm.)

(3) Package Type: SIP-3 (Bulk Pack)

Sensor location to be added



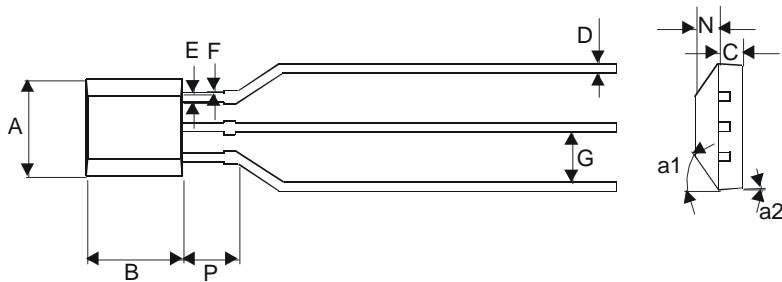
SIP-3 (Bulk Pack)		
Dim	Min	Max
A	3.9	4.3
a1	5° Typ	
a2	5° Typ	
a3	45° Typ	
a4	3° Typ	
B	2.8	3.2
C	1.40	1.60
D	0.33	0.432
E	0.40	0.508
F	0	0.2
G	1.24	1.30
H	2.51	2.57
J	0.35	0.43
L	14.0	15.0
N	0.63	0.84
P	1.55	-
All Dimensions in mm		



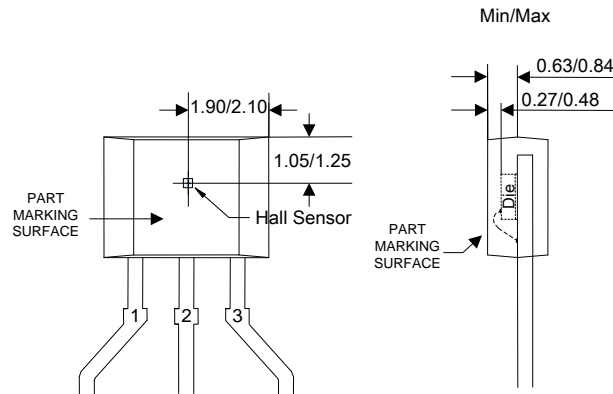
Sensor Location

Package Outline Dimensions (Cont.) (All dimensions in mm.)

(4) Package Type: SIP-3 (Ammo Pack)



SIP-3 (Ammo Pack)		
Dim	Min	Max
A	3.9	4.3
a1	45° Typ	
a2	3° Typ	
B	2.8	3.2
C	1.40	1.60
D	0.35	0.41
E	0.43	0.48
F	0	0.2
G	2.4	2.9
N	0.63	0.84
P	1.55	-
All Dimensions in mm		

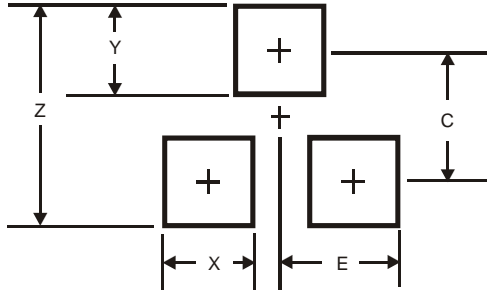


Sensor Location

Suggested Pad Layout

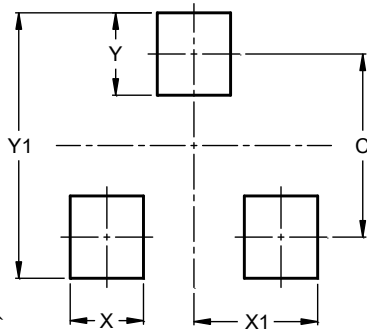
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(1) Package Type: SC59



Dimensions	Value (in mm)
Z	3.4
X	0.8
Y	1.0
C	2.4
E	1.35

(2) Package Type: SOT23



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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